



Techday

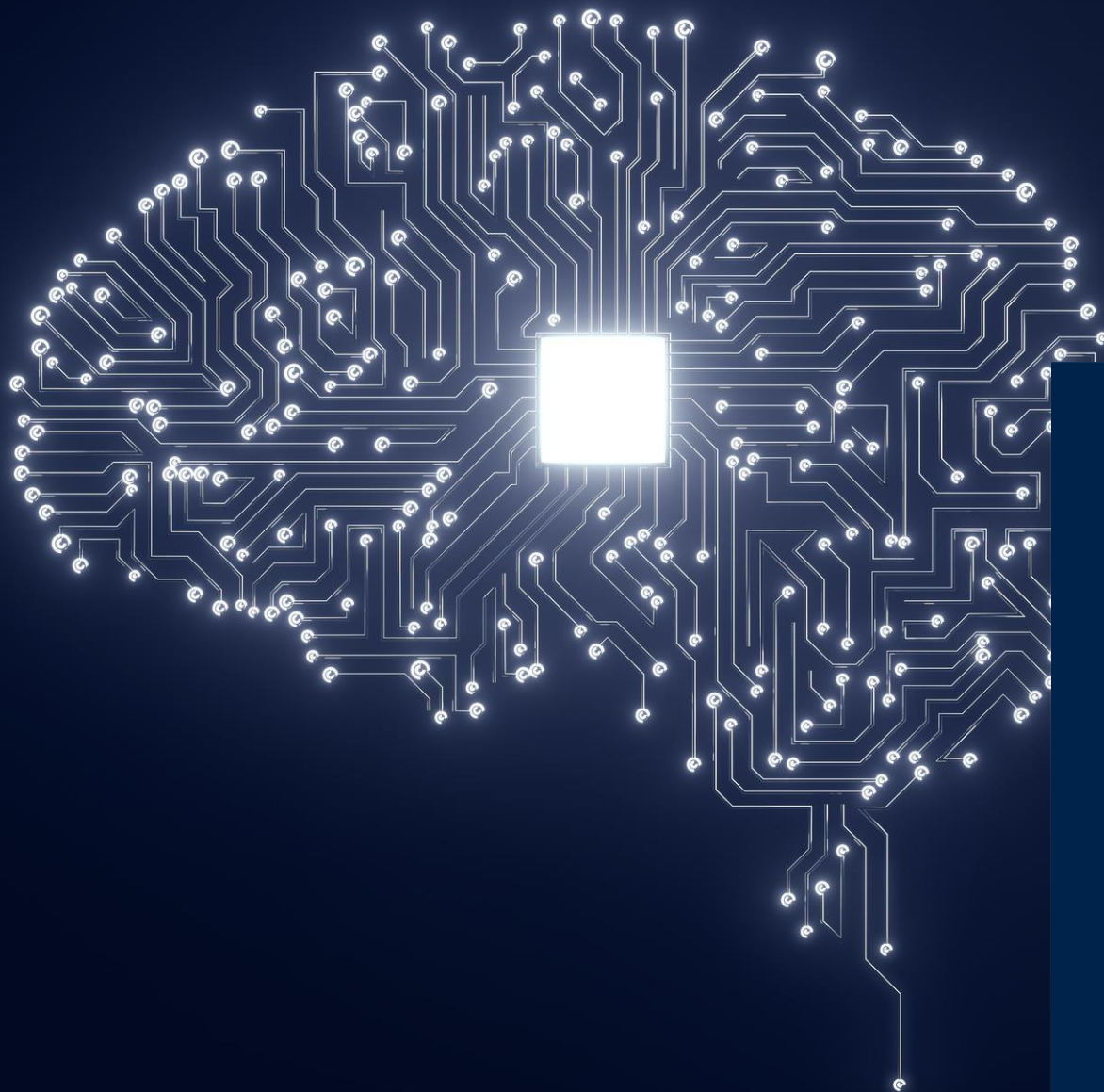
Taiwan | 2023

OUR TECHNOLOGY STARTS WITH YOU

**Sub-track III –
IoT & Connectivity Presentation**



life.augmented



Advanced MEMS sensors in the sustainable onlife era

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Smart sensors making our world a better place

Offline Era



2000

A paradigm change in the man-machine interface

MEMS technology: from a concept to a product.

Online Era



2010

Sensor proliferation and connections to the Cloud

Performance improvement and technology fusion.

Onlife Era



2020

The fusion of technology and life

MEMS sensors able to sense, process, and act.

Sustainable Onlife



Sustainable sensorization of the world

MEMS sensors sending only the **meaningful data** to the cloud

Sensors at the heart of our interactions with the digital world



**Human
centered**



Sustainable

Sensors are the key components to **bridge** the **physical** and the **digital** worlds



Sensors becoming **smart** answer **human expectations** while ensuring a **sustainable future**



Track and monitor orientation in 3D space



Detect and track device orientation with the **embedded low power sensor fusion** algorithm with **30 μ A**

Plug and play solution that provided **6x game rotation vector** (accelerometer + gyroscope) & **Gyro-bias calibration**

Ultra-low power operation
50% power reduction vs. external MCU⁽³⁾ processing

Static accuracy⁽¹⁾: 0.5, 1.5, 1.5 deg
Low dynamic accuracy⁽¹⁾: 0.7, 0.5, 0.5 deg
Calibration time⁽²⁾: 0.8 s
Orientation stabilization time: 0.7 s
Extra power: 30 μ A @ 120 MHz

Context awareness detection

Adding intelligence in the edge with MLC and FSM

Embedded MLC and FSM process XL & Gyro data to detect usage conditions with **no interaction required** with external processor

Few examples*

1 μA

Identify activity and inactivity
(i.e., wake up the system only when needed)

6 μA

Gym activity recognition

6 μA

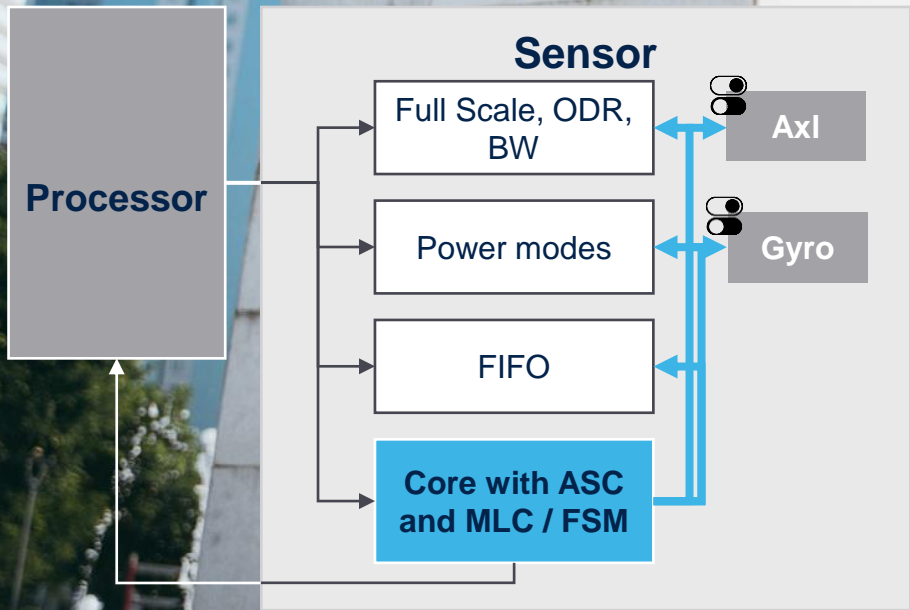
Wrist tilt detection for display wake up

From 1 μA
to 35 μA

Scalable solution to detect **free fall, shock** and fall **height estimation** (or Man Down)

Adaptive self configuration (ASC)

From “Always-On” to “Smart, Always-Aware”



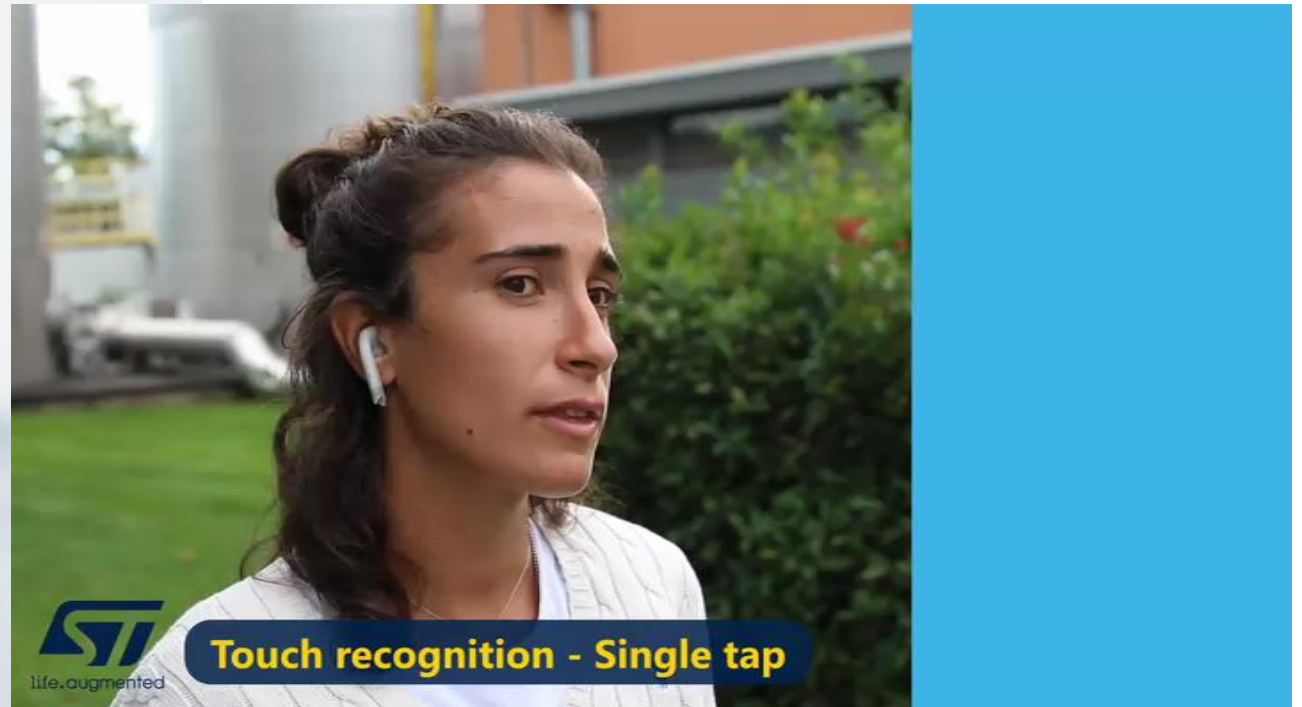
The device automatically **reconfigures itself**, based on the actual context, maximizing the **system efficiency**.

MLC and FSM detect the context without the need of additional data processing

ASC allows to independently configure Gyro and XL channels.
No tradeoff required!

User interfaces


Qvar electrodes to improve UI: Touch and Swipe



- Sensor fusion between Qvar and 6x IMU improves the user experience accuracy reducing false positives
- Support for single/long and multiple touch and swipe

Free fall height estimation

Beware: LSM6DSV16X can track your shock!



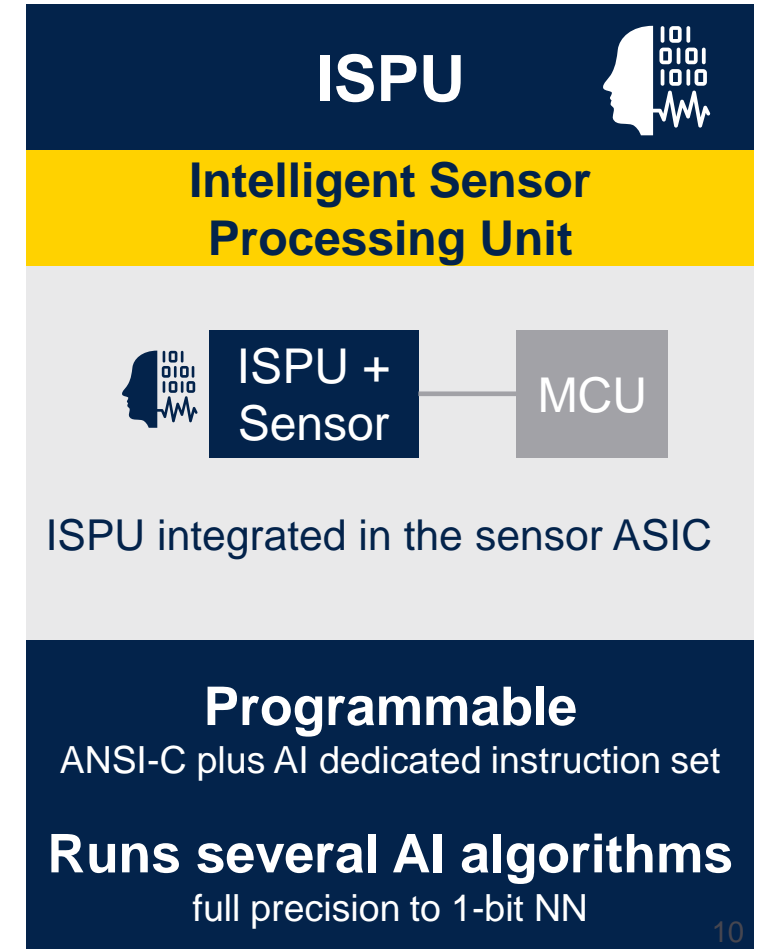
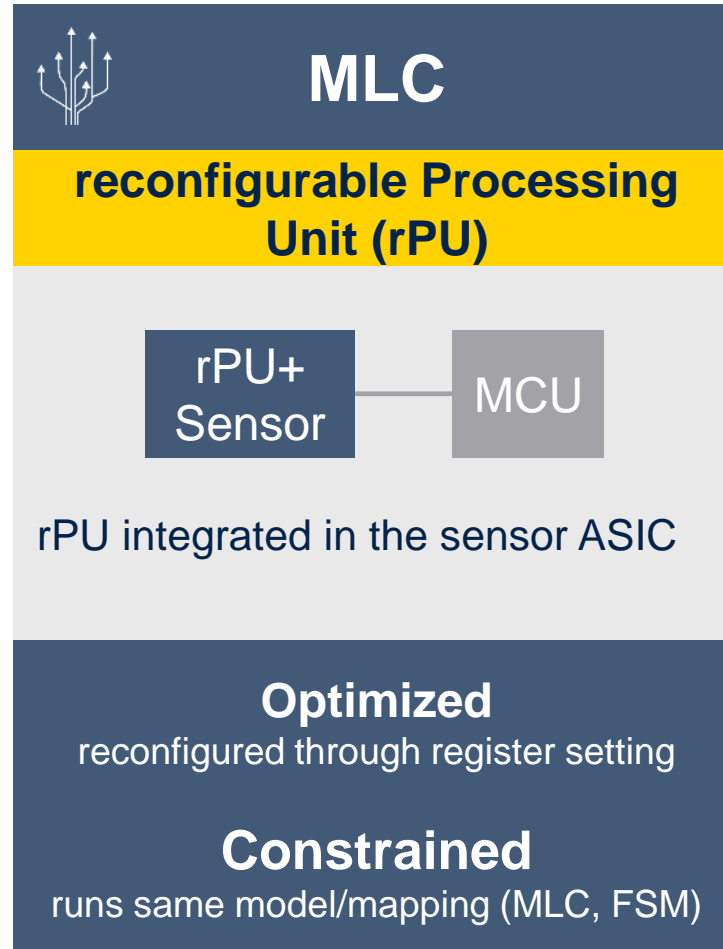
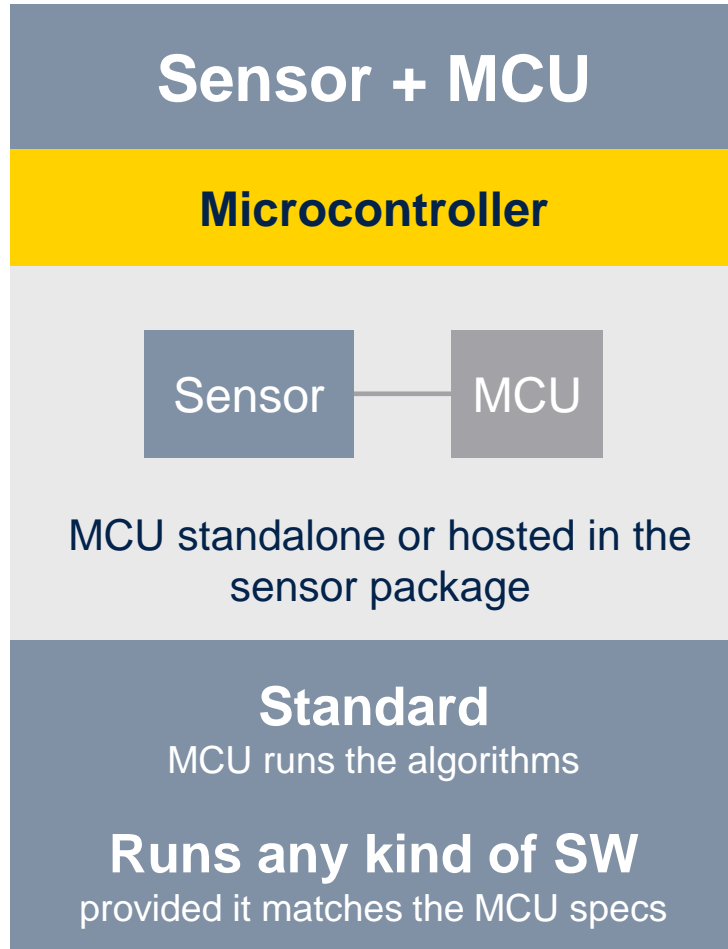
Scalable solution to detect **shock**, **free fall**, and estimate height of the free fall

Embedded processing and **FSM** detect the context without the need of additional data processing at system level

From free fall **height exceedance** detection, to the **accurate height** estimation, from **1 μ A** to **35 μ A**, always the right algorithm

* Power consumption values are related to the embedded processing

Moving the intelligence at the edge

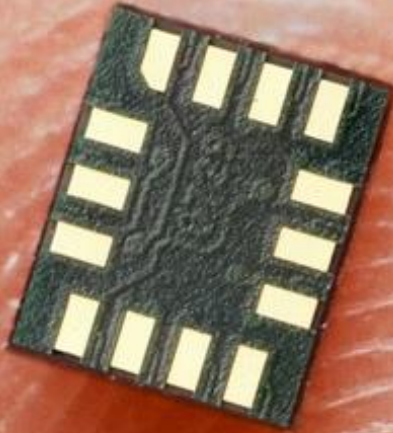


ISPU intelligent sensor processing unit



Highly specialized DSP* for machine learning and processing

Super
tiny
silicon



Unique solution for TinyML with **machine learning (ML)**, **binary neural network (BNN)**, and **processing** capabilities



Lowest power consumption IoT node in the market with AI in the edge



Productivity: empowers 10M+ C language developers
Complement STM32 MCU portfolio for AI

vAFE, because the world is analog

MEMS sensing

- We use a **high performance AFE** in MEMS sensors: it reads and converts capacitance change $\sim 0.1\text{aF}^*$
- We have developed **specific low noise IP and silicon technologies**

an additional AFE: vAFE

- An auxiliary AFE enables reading of analog signals, that are complementary to motion signal

vertical AFE

vAFE and Motion signals are intrinsically **synchronous**.

The result is a unique **context aware analysis** done in-the-edge, thus low power and with the minimum possible latency.

And we do it in standard package dimensions.

vAFE: opening new application frontiers

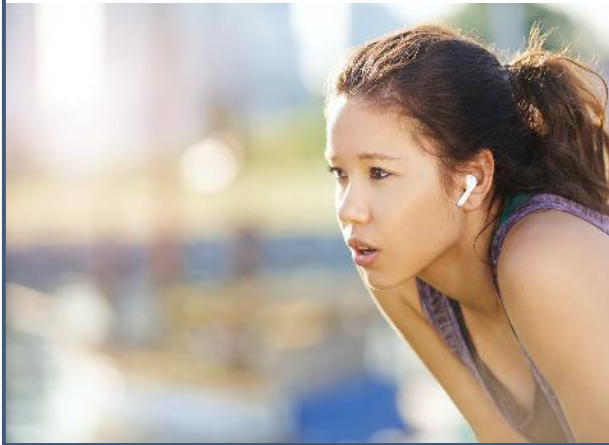
Smartphone & Camera

Presence detection
Activity tracking



TWS

In-Ear detection
Touch-Multiple Touches
Long press



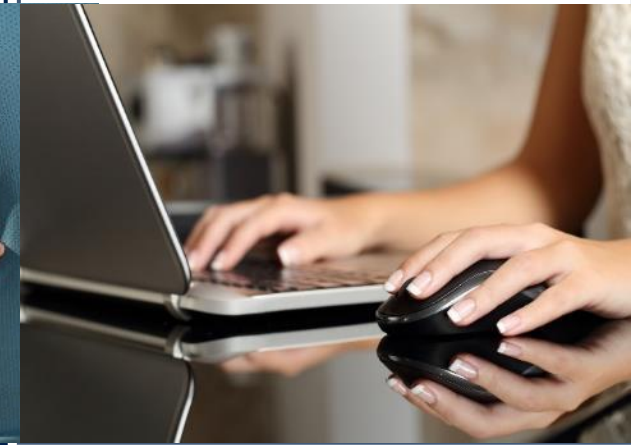
Wearable

Presence detection
Enhanced activity tracking
Biometric data



IoT

Presence detection
Energy Saving



Smart Ring: the 2023 trend runs ST sensors



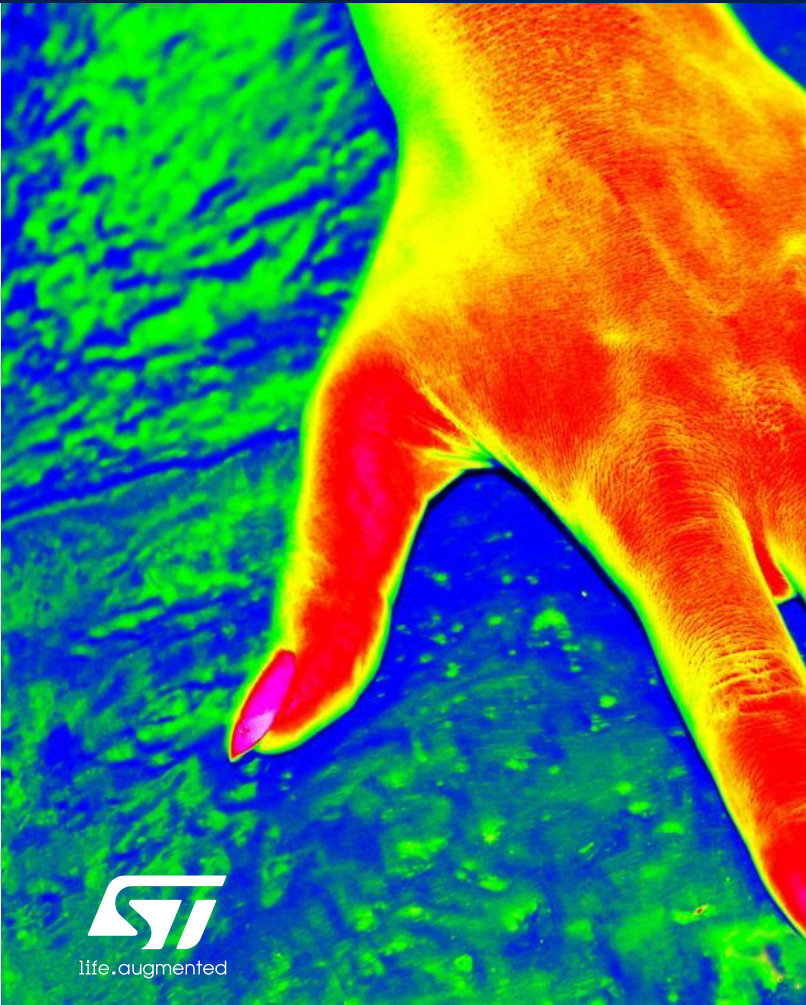
Battery constrained solutions require **low power, in-the-edge processing**

LIS2DUX features single-digit μA power consumption with embedded AI (MLC, FSM, ASC)

LIS2DUXS also features a vAFE
LSM6DSV16X includes a gyro for more functionalities

IR sensor STHS34PF80, ready to go

STHS34PF80 IR Sensor based TMOS technology starts finally in Mass Production, we are ready to go market.



ST IR sensing element

Sensor measures in the wavelength range from 5 to 20 μm



Human body

radiation is $\sim 9.8 \mu\text{m}$, at in the center of the sensor's range



Biometric

Presence detection and temperature measurement

MEMS sensors roadmap



New generation MEMS sensors

	Features	Products	Applications
iNEMO® Inertial Module 	Embedded ISPU N version for NEAI	LSM6DSO16IS ISM330IS/N	
	MLC, FSM, ASC, SFLP, Qvar, Audio AXL, BC	LSM6DSV16X LSM6DSV32X LSM6DSV16BX	
Accelerometers 	ULP , 12b resolution, AAF, 128 samples FIFO ;(i.e. 0.47µA @6Hz ODR) FSM, MLC, Pedometer, Qvar™	LIS2DU12 LIS2DUX12 LIS2DUXS12	
Pressure Sensors 	Water resistant & WP, better accuracy, lower power consumption, Dual FS Qvar™	LPS22DF LPS28DFW ILPS22QS ILPS28QSW	
IR Sensor	Presence Detection up to 4 meter 80° Field Of View TMOS sensor	STHS34PF80	

FS: Full Scale
 FSM: Finite State Machine
 ASC: Adaptive Self Configuration
 AAF: Anti-Aliasing Filter
 ISPU: Intelligent Sensor Proc Unit
 WP: WaterProof
 ULP: Ultra Low Power Mode
 MLC: Machine Learning Core
 SFLP: Sensor Fusion Low Power
 Qvar: Electrostatic Charge Variation
 NEAI: Nano Edge AI
 TDM: Time Density Modulation

Takeaway



Takeaways

1

LSM6DSV16X, LSM6DSV16BX, LIS2DUXS12 and ILPS28QSW are innovative sensing solutions with unique IP

2

Qvar is a new sensing capability that opens the door to many new functions such as in ear detection, user interface, water leakage detection without the need of additional sensors

3

Machine learning core, finite state machine, embedded sensor fusion low power move the processing at the edge, in the sensor, allowing great system optimization and performance improvement

Our technology starts with You



Find out more at www.st.com/MEMS

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